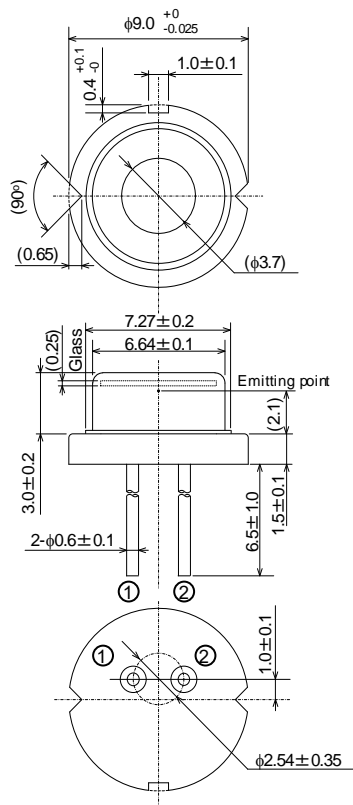




## HL65303HD

665nm/1.3W AlGaInP Laser Diode

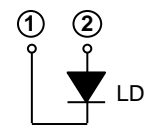
### Outline



(Unit: mm)

### Internal Circuit

HL65303HD



### Features

- Single emitter
- Optical output power: 1.3W (CW)
- Wavelength: 665nm Typ.
- High wall plug efficiency: 40% Typ.
- High heat dissipation  $\phi$  9mm CAN package
- Multi transverse mode
- TE mode oscillation

### Application

- Photodynamic therapy
- Medical, healthcare
- Life science
- Laser modules

## Absolute Maximum Ratings (Tc=25°C)

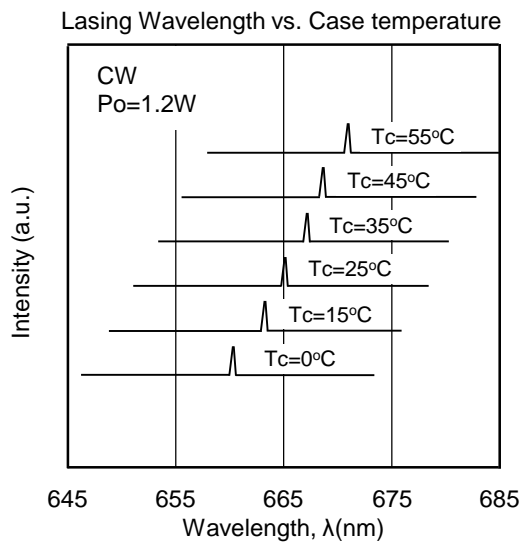
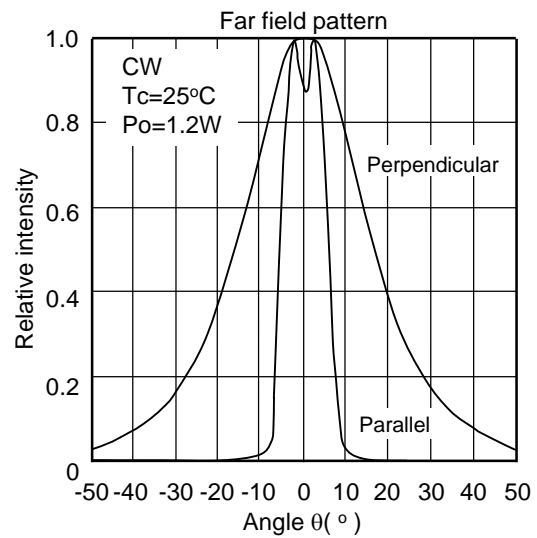
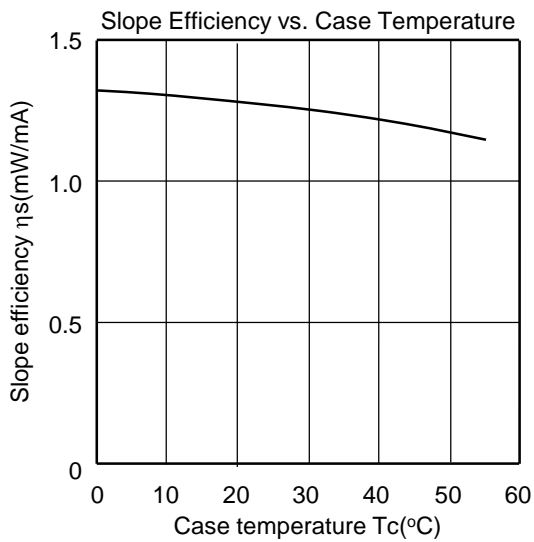
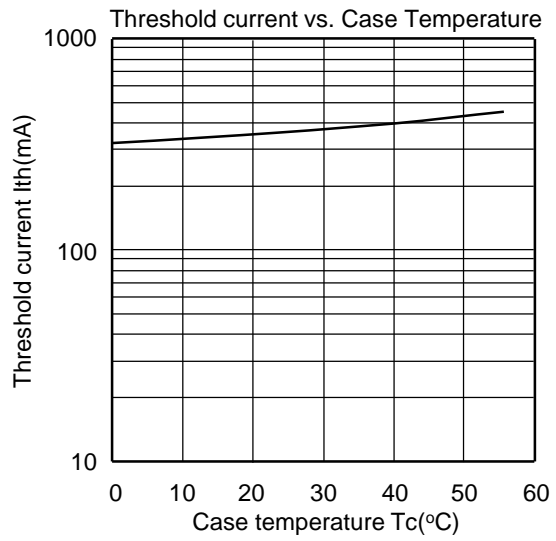
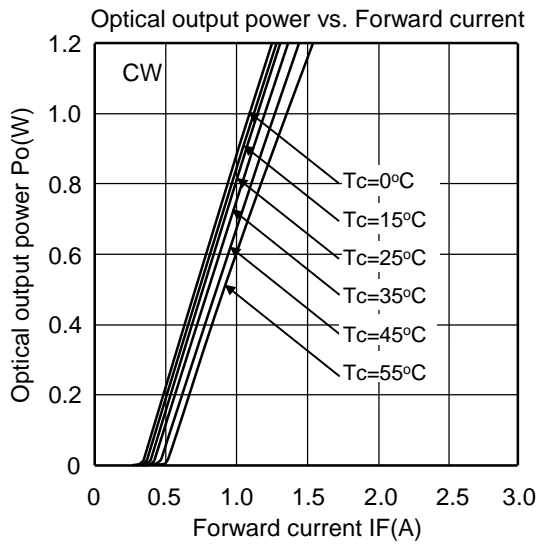
Item	Symbol	Ratings	Unit
Optical output power	Po	1.3	W
LD Reverse Voltage	V <sub>R(LD)</sub>	2	V
Operating Temperature <sup>Note1)</sup>	Topr	-10 ~ +55	°C
Storage Temperature	Tstg	-40 ~ +85	°C

Note1) Operating temperature is defined by Case temperature "Tc". High increase in temperature of LD chip itself is expected during operation due to high current density. Thus, without proper heat dissipation, it is observed that no specific output power is achieved or it results to LD degradation. It is advised that sufficient measure of heat dissipation should be taken so that LD's maximum operating temperature is not exceeded during actual operation.

## Optical and Electrical Characteristics (Tc=25°C)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Threshold current	I <sub>th</sub>	-	370	570	mA	-
Operating current	I <sub>op</sub>	-	1350	1650	mA	Po=1.2W
Operating voltage	V <sub>op</sub>	-	2.25	2.7	V	Po=1.2W
Beam divergence Parallel to the junction	θ <sub>//</sub>	3	10	20	°	Po=1.2W, FWHM
Beam divergence Perpendicular to the junction	θ <sub>⊥</sub>	23	32	43	°	Po=1.2W, FWHM
Lasing Wavelength	λ <sub>p</sub>	660	665	670	nm	Po=1.2W

## Typical Characteristic Curves



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